ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	IPC, Bannock	burn, Illinois. A	ll rights reserved u ntions.	under both	This docume level parts, t	ent is a declar he declaration	ration of n encon	of the substance mpasses all love	es withir wer level	the manufact materials for	urer listed i which the n	tem. N nanufao	ote: if the	e item is an as s engineering	sembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Ty _I http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					erials and M	als and Mfg Information				
Supplier Information																
Company name*	Company un	Company unique ID			Unique ID Authority					Respons	Response Date*					
nsemi											2025-06-07					
Contact Name Titl			Title - Contact			Phone - Contact*					Email -	Email - Contact*				
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA					Produc	Product-Env-Stewards@onsemi.com					
uthorized Representative*	Title - Repres	Title - Representative			Phone - Representative*				Email -	Email - Representative*						
Product-Env-Stewards		Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com					
Requester Item Number	ester Item Number Mfr Iter		n Number Mfr Item Name			Effective Da	ate V	ersion	Manufacturing Site		,	Weight	t*	UOM	Unit Type	
	NCV74	71BDQ5R2G	CAN 2LIN 500MA BUBO SBC		2	2025-06-07			PHG		:	515.45		mg	Each	
Ianufacturing Proccess Inform	ation					- 	1		·						1	
Terminal Plating / Grid Array M	laterial	Terminal Base A	Alloy J	J-STD-020 MSL R		Peak Process		Body Temperature Max Time at Pea		ık Temperat	Temperature Numb		of Reflow Cyc	les		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 3		3		260		С	30	30		ds 3	3			
comments																
TTENTION: MSL 3 Rated item requir	es Bake and l	Dry Pack (after	electrical test)													
or more information regarding materia	l composition	please refer to	page 3													

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	15.99	mg	Supplier	Silicon (Si)	7440-21-3		15.99	mg
Die Attach	2.86	mg		Epoxy resin	proprietary data		0.286	mg
			Supplier	Silver (Ag)	7440-22-4		2.288	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.286	mg
Lead Frame	172.4	mg	Supplier	Zinc (Zn)	7440-66-6		0.1724	mg
			Supplier	Iron (Fe)	7439-89-6		3.9652	mg
			Supplier	Copper (Cu)	7440-50-8		168.09	mg
			Supplier	Phosphorus (P)	7723-14-0		0.1724	mg
Mold Compound-Black	322.04	mg		Epoxy resin	proprietary data		24.153	mg
			Supplier	Phenolic Resin	Proprietary Data		8.051	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		24.153	mg
			Supplier	Carbon Black (C)	1333-86-4		1.6102	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		264.0728	mg
Plating	1.62	mg	Supplier	Palladium (Pd)	7440-05-3		0.08	mg
			В	Nickel (Ni)	7440-02-0		1.4599	mg
			Supplier	Gold (Au)	7440-57-5		0.08	mg
Wire Bond - Au	0.54	mg	Supplier	Gold (Au)	7440-57-5		0.54	mg